



U.S. Patent Documents

Examiner Initials	Document No.	Date	Name	Class	Subclass	Filing Date If Approp.
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<i>Rehm</i>	5,283,414	2/94	Straemke (corresponds to DE 40 07 123 A1)			
	5,290,381	3/94	Nozawa et al			
	5,356,672	10/94	Schmitt, III et al			
	5,362,361	11/94	Tatsumi			
	5,366,585	11/94	Robertson et al			

Foreign Patent Documents

Document No.	Date	Country	Class	Subclass	Translation Yes	Translation No
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<i>Rehm</i> 56-67925	6/81	Japan			(abstract)	
<i>Rehm</i> 57-23228	2/82	Japan			(abstract)	
<i>Rehm</i> 58-153332	9/83	Japan			(abstract)	
<i>Rehm</i> 59-144132	8/84	Japan			(abstract)	
<i>Rehm</i> 62-95828	5/87	Japan			(abstract)	
<i>Rehm</i> 62-218570	9/87	Japan			(abstract)	
<i>Rehm</i> 63-5526	1/88	Japan			(abstract)	
<i>Rehm</i> 63-75034	5/88	Japan			(abstract)	
<i>Rehm</i> 3-64025	3/91	Japan			(abstract)	
<i>Rehm</i> DE 40 07 123 A1	9/91	Deutschland (corresponds to U.S. Patent No. 5,283,414)				
<i>Rehm</i> 4-184924	7/92	Japan			(abstract)	
<i>Rehm</i> 4-214873	8/92	Japan			(abstract)	
<i>Rehm</i> EP 0 488 307 B1	6/92	European				
<i>Rehm</i> 5-60256	3/93	Japan			(abstract)	
<i>Rehm</i> 5-211125	8/93	Japan			(abstract)	
<i>Rehm</i> 5-266845	10/93	Japan			(abstract)	
<i>Rehm</i> EP 0 272 140 B1	2/94	European				
<i>Rehm</i> 6-188220	7/94	Japan			(abstract)	
<i>Rehm</i> 6-196410	7/94	Japan			(abstract)	
<i>Rehm</i> 7-22404	1/95	Japan			(abstract)	
<i>Rehm</i> EP 0 367 289 B1	2/95	European				
<i>Rehm</i> 7-147247	6/95	Japan			(abstract)	
<i>Rehm</i> 7-312363	11/95	Japan			(abstract)	
<i>Rehm</i> EP 0 467 397 B1	12/95	European				
<i>Rehm</i> EP 0 688 037 B1	12/95	European				
<i>Rehm</i> 8-51099	2/96	Japan			(abstract)	
<i>Rehm</i> 8-144072	6/96	Japan			(abstract)	
<i>Rehm</i> 8-186093	7/96	Japan			(abstract)	
<i>Rehm</i> EP 0 734 047 A2	9/96	European				
<i>Rehm</i> 9-157832	6/97	Japan			(abstract)	
<i>Rehm</i> 9-275092	10/97	Japan			(abstract)	

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Applicant: T. MASUDA, et al  
Filing Date: October 20, 1999  
Group: 1765  
Page 2 of 2

Other Documents (including Author, Title, Date, Pertinent Pages, etc.)

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*PLM* "Suppression Shield for RF Plasma", W. J. Curry et al, IBM Technical Disclosure Bulletin, Vol. 22, No. 11, April 1980, pp 4909-4910

Examiner

*Stlepanek*

Date Considered

*05/22/02*

\*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.